Power MOSFET

40 V, 7.5 m Ω , 86 A, Single N–Channel, SO–8FL

Features

- Low R_{DS(on)}
- Low Capacitance
- Optimized Gate Charge
- AEC-Q101 Qualified and PPAP Capable
- NVMFS5833NWF Wettable Franks Option for Enhanced Optical Inspection
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	40	V
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V
Continuous Drain Current $R_{\Psi J-mb}$ (Notes 1, 2, 3 & 4)	Steady State	$T_{mb} = 25^{\circ}C$	I _D	86	Α
		T _{mb} = 100°C		61	
Power Dissipation $R_{\Psi J-mb}$ (Notes 1, 2, 3)		T _{mb} = 25°C	P _D	112	W
		$T_{mb} = 100^{\circ}C$		56	
Continuous Drain Cur-		T _A = 25°C	I _D	16	Α
rent $R_{\theta JA}$ (Notes 1, 3 & 4)	Steady State	T _A = 100°C		11	
Power Dissipation		T _A = 25°C	P _D	3.7	W
R _{θJA} (Notes 1 & 3)		T _A = 100°C		1.8	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	324	Α
Operating Junction and Storage Temperature			T _J , T _{stg}	-55 to 175	°C
Source Current (Body Diode)			Is	86	Α
Single Pulse Drain-to-Source Avalanche Energy (T _J = 25°C, I _{L(pk)} = 36 A, L = 0.1 mH)			E _{AS}	65	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			T _L	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Mounting Board (top) - Steady State (Notes 2, 3)	$R_{\Psi J-mb}$	1.3	°C/W
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	41	

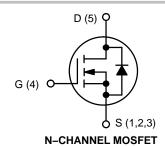
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Psi (Ψ) is used as required per JESD51–12 for packages in which substantially less than 100% of the heat flows to single case surface.
- 3. Surface–mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 4. Continuous DC current rating. Maximum current for pulses as long as 1 second are higher but are dependent on pulse duration and duty cycle/



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	7.5 mΩ @ 10 V	86 A





SO-8 FLAT LEAD CASE 488AA STYLE 1



5833 = Specific Device Code xx = N (NVMFS5833N) or WF (NVMFS5833NWF)

A = Assembly Location Y = Year

W = Work Week ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping [†]
NVMFS5833NT1G	SO-8FL (Pb-Free)	1500 / Tape & Reel
NVMFS5833NT3G	SO-8FL (Pb-Free)	5000 / Tape & Reel
NVMFS5833NWFT1G	SO-8FL (Pb-Free)	1500 / Tape & Reel
NVMFS5833NWFT3G	SO-8FL (Pb-Free)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

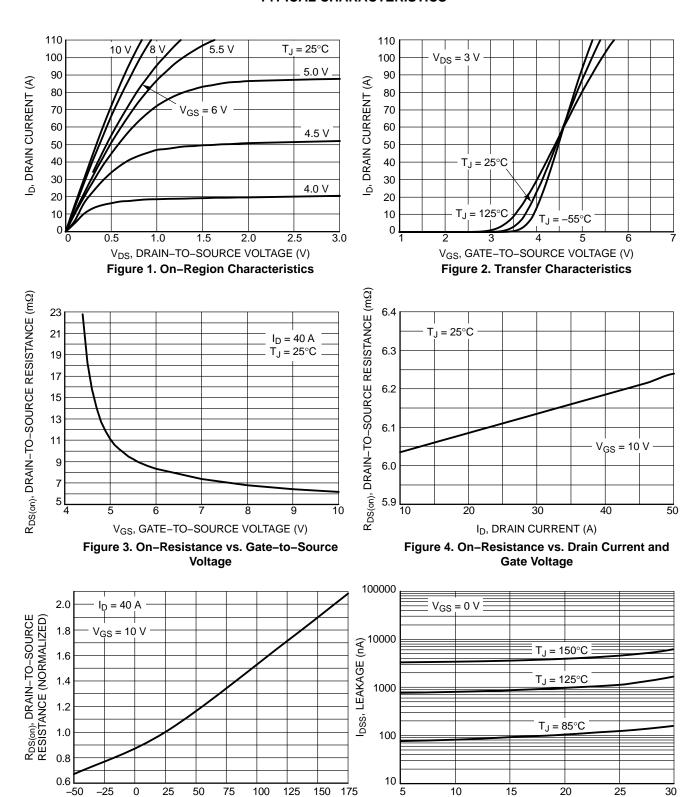
Symbol	Test Condition		Min	Тур	Max	Unit
-				•		•
V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
V _{(BR)DSS} /T _J				32.6		mV/°C
I _{DSS}	V _{GS} = 0 V.	T _J = 25°C			1.0	μА
	$V_{DS} = 40 \text{ V}$	T _J = 125°C			100	
I _{GSS}	V _{DS} = 0 V, V _{GS} =	±20 V			±100	nA
V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 1$	250 μΑ	2.0		3.5	V
V _{GS(TH)} /T _J				-7.6		mV/°C
R _{DS(on)}	V _{GS} = 10 V, I _D = 40 A			6.2	7.5	mΩ
9FS	$V_{DS} = 5 \text{ V}, I_{D} = 5 \text{ A}$			38		S
				•		•
C _{iss}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 25 V			1714		pF
C _{oss}				210		
C _{rss}				144		
Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 32 V, I _D = 40 A			32.5		nC
Q _{G(TH)}				2.77		
Q _{GS}				7.37		
Q_{GD}		ŀ		9		
ote 6)				•		•
t _{d(on)}				10.23		ns
t _r	Vcs = 10 V. Vns :	= 20 V.		19.5		
t _{d(off)}	$I_D = 40 \text{ A}, R_G = 2.5 \Omega$			23.60		
t _f				3.00		
ERISTICS				•		•
V_{SD}	V _{GS} = 0 V, I _S = 40 A	$T_J = 25^{\circ}C$		0.85	1.2	V
		T _J = 125°C		0.7		1
t _{RR}	$V_{GS} = 0 \text{ V, } d_{IS}/d_t = 100 \text{ A/}\mu\text{s,}$ $I_S = 40 \text{ A}$			23.5		ns
t _a				13.5		
				-		-1
t _b	$I_S = 40 A$			10		
	V(BR)DSS V(BR)DSS/TJ IDSS IGSS VGS(TH) VGS(TH)/TJ RDS(on) GFS Coss Crss QG(TOT) QGS QGD ote 6) td(on) tr td(off) tf ERISTICS VSD	V(BR)DSS	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{ c c c c }\hline V_{(BR)DSS} & V_{GS} = 0 \text{ V, } I_D = 250 \mu\text{A} & 40\\ \hline V_{(BR)DSS}/T_J & & & & & & & & & & & & & & & & & & &$	$\begin{array}{ c c c c c }\hline V_{(BR)DSS} & V_{GS} = 0 \ V, \ I_{D} = 250 \ \mu A & 40 \\ \hline V_{(BR)DSS}/T_{J} & 32.6 \\ \hline I_{DSS} & V_{GS} = 0 \ V, \\ V_{DS} = 40 \ V & T_{J} = 25^{\circ}C \\ \hline I_{GSS} & V_{DS} = 0 \ V, V_{GS} = \pm 20 \ V \\ \hline \hline V_{GS(TH)} & V_{GS} = V_{DS}, \ I_{D} = 250 \ \mu A & 2.0 \\ \hline V_{GS(TH)}/T_{J} & -7.6 \\ \hline R_{DS(on)} & V_{GS} = 10 \ V, \ I_{D} = 40 \ A & 6.2 \\ \hline g_{FS} & V_{DS} = 5 \ V, \ I_{D} = 5 \ A & 38 \\ \hline \hline C_{iss} & V_{GS} = 0 \ V, \ f = 1.0 \ MHz, \ V_{DS} = 25 \ V & 210 \\ \hline C_{rss} & 144 \\ \hline Q_{G(TOT)} & 32.5 \\ \hline Q_{GS} & 10 \ V, \ V_{DS} = 32 \ V, \\ \hline Q_{GS} & 9 \\ \hline ote 6) & 10.23 \\ \hline t_{f} & V_{GS} = 10 \ V, \ V_{DS} = 20 \ V, \\ \hline I_{D} = 40 \ A, \ R_{G} = 2.5 \ \Omega & 23.60 \\ \hline t_{f} & 3.00 \\ \hline ERISTICS & V_{GS} = 0 \ V, \ d_{IS}/d_{I} = 100 \ A/us. & 13.5 \\ \hline \end{array}$	$\begin{array}{ c c c c c }\hline V_{(BR)DSS} & V_{GS} = 0 \text{ V, } I_D = 250 \ \mu\text{A} & 40 \\ \hline V_{(BR)DSS}/T_J & 32.6 \\ \hline \\ I_{DSS} & V_{GS} = 0 \text{ V, } \\ V_{DS} = 40 \text{ V} & \hline \\ T_J = 125^{\circ}\text{C} & 1.0 \\ \hline \\ I_{GSS} & V_{DS} = 0 \text{ V, } V_{GS} = \pm 20 \text{ V} & \pm 100 \\ \hline \\ V_{GS(TH)} & V_{GS} = V_{DS}, \ I_D = 250 \ \mu\text{A} & 2.0 & 3.5 \\ \hline \\ V_{GS(TH)}/T_J & -7.6 & \\ \hline \\ R_{DS(on)} & V_{GS} = 10 \text{ V, } I_D = 40 \text{ A} & 6.2 & 7.5 \\ \hline \\ g_{FS} & V_{DS} = 5 \text{ V, } I_D = 5 \text{ A} & 38 \\ \hline \\ \hline \\ C_{iss} & \\ C_{oss} & \\ C_{rss} & 1444 & \\ \hline \\ Q_{G(TOT)} & 32.5 & \\ \hline \\ Q_{G} & 10 \text{ V, } V_{DS} = 32 \text{ V, } \\ I_D = 40 \text{ A} & 7.37 & \\ \hline \\ Q_{GS} & 9 & \\ \hline \\ t_f & V_{GS} = 10 \text{ V, } V_{DS} = 20 \text{ V, } \\ I_D = 40 \text{ A, } R_G = 2.5 \ \Omega & 23.60 \\ \hline \\ t_f & 3.00 & \\ \hline \\ ERISTICS & \\ \hline \\ t_8 & V_{GS} = 0 \text{ V, } d_{Is}/d_I = 100 \text{ A/us.} & 13.5 \\ \hline \end{array}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

5. Pulse Test: pulse width = 300 μs, duty cycle ≤ 2%.

6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



 $\label{eq:TJ} \textbf{T}_{J}, \, \textbf{JUNCTION TEMPERATURE (°C)} \\ \textbf{Figure 5. On-Resistance Variation with} \\ \textbf{Temperature} \\$

Figure 6. Drain-to-Source Leakage Current vs. Voltage

V_{DS}, DRAIN-TO-SOURCE VOLTAGE (V)

TYPICAL CHARACTERISTICS

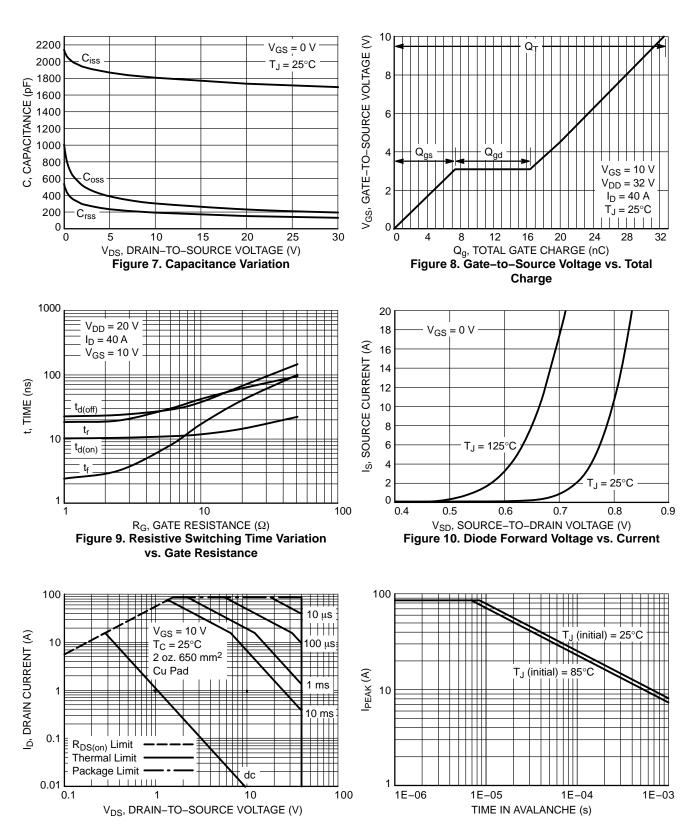


Figure 11. Maximum Rated Forward Biased Safe Operating Area

Figure 12. Avalanche Characteristics

TYPICAL CHARACTERISTICS

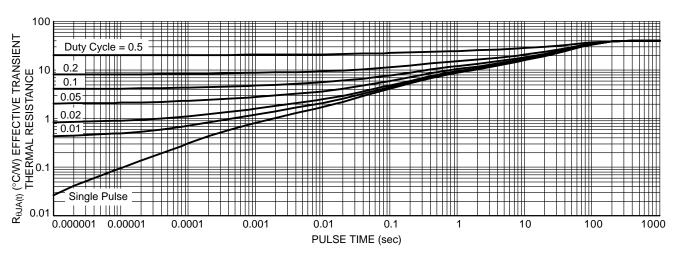
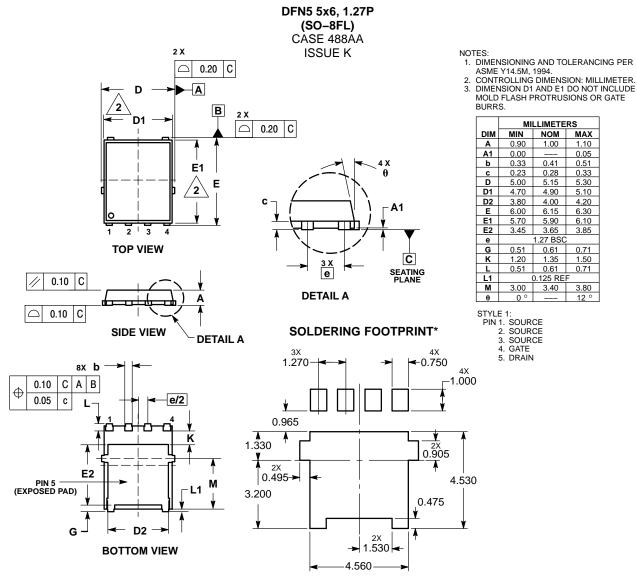


Figure 13. Thermal Response

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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